PRODUCT CHANGE NOTICE						
PART NUMBER(S):	PCN No.: 06-0130-34					
Please see attachment.	DATE: January 30, 2006					
PART DESCRIPTION:						
Power Management and Interface Products – Change in Wafer Fabrication Site						
LEVEL OF CHANGE:						
[X] Level I, Customer Approval. [ ] Level II, Customer Information.						
PRODUCT ATTRIBUTE AFFECTED:						
[ ] Material Change [ ] Design Change [ <b>X</b> ] Process Change	<ul><li>[ ] Data Sheet Change</li><li>[ ] Package Change</li><li>[ ] Packing / Shipping</li></ul>					
[X] Other, Explain: Wafer Fabrication Site Transfer						
DESCRIPTION OF CHANGE:						
Announcing transfer of certain Power Management and Interface Products from Hillview wafer fabrication facility to wafer foundry Silan. See attached Product List no. 34.						
REASON FOR CHANGE:						
Power Management and Interface products as listed are being transferred to external wafer foundry, due to cessation of operations of the Sipex Hillview Wafer Fabrication manufacturing site.						
	PRODUCT CHARACTERIZATION COMPLETED AND SAMPLES* AVAILABLE (DATE): November 5, 2006					

<sup>\*</sup> Samples representative of product from the Product Family being transferred.



	PRODUCT CHANGE NOTICE				
EARLIEST DATE OF PRODUC SHIPMENTS: February 3, 200	_				
EFFECTIVITY CHANGE DATE	OR DATE CODE:	Work week associ	ated wit	th earliest production shipment.	
[ ] STANDARD DISTRIBUT	ION		[X]	CUSTOM DISTRIBUTION	
PERSON TO CONTACT WITH	QUESTIONS:				
Fred Claussen					
VP Quality Assurance and Reli Sipex Corporation Phone Number: 408-935-7644 FAX NUMBER: 408-935-7678	ability				



## PRODUCT CHANGE NOTICE

PCN No.: 06-0130-34

List 34

SP707CN

SP707CN-L

SP707CP

SP707CP-L

SP707CU

SP707CU-L

SP707EN

SP707EN-L

SP707EP

SP707EP-L

SP707EU

SP707EU-L

SP707XN

SP707XN-L

SP707XP

SP707XP-L

SP708CN

SP708CN-L

SP708CP

SP708CP-L

SP708CU

SP708CU-L

SP708EN

SP708EN-L

SP708EP

SP708EP-L

SP708EU

SP708EU-L

SP708XN

SP708XN-L

SP708XP

SP708XP-L